## CENG 3420 Computer Organization \& Design

## Lecture 01: Introduction

Bei Yu

CSE Department, CUHK
byu@cse.cuhk.edu.hk
(Textbook: Chapters 1.3 \& 1.4)

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Course Information

## Course Administration

## Instructor:

- Bei Yu (byu@cse.cuhk.edu.hk)
- Office: SHB 907
- Office Hrs: H14:30-16:30


## Tutors:

- Chen Bai (cbai@cse.cuhk.edu.hk)
- Hongduo Liu (hdliu21@cse.cuhk.edu.hk)
- Yuxuan Zhao (yxzhao21@cse.cuhk.edu.hk)
- Shixin Chen (sxchen22@cse.cuhk.edu.hk)
- Su Zheng (szheng22@cse.cuhk.edu.hk)


## Grading Information

## Grade Determinates

```
    5% Attendance
    15% Homework
    15% Midterm (Mar. 18)
    30% Three Labs (Individual project)
    35% Final Exam
```

- Late submission per day is subject to $10 \%$ of penalty.
- A student must gain at least $50 \%$ of the full marks in order to pass the course.
- A student must attend at least $80 \%$ of lectures in order to gain all class attendance credits.


## General References

## Textbook:

- Computer Organization and Design, RISC-V Edition
- Soft copy, amazon.cn, or amazon.com


## Manuals:



- LC-3 Instruction Set Architecture (ISA)
- Lab tutorials (slides)


## Slides:

- On the course web page before lecture
- Summary may be uploaded afterwards


## Course Content

- Introduction to the major components of a computer system, how they function together in executing a program.
- Introduction to CPU datapath and control unit design
- Introduction to techniques to improve performance and energy-efficiency of computer systems
- Introduction to multiprocessor architecture


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## Philosophy

To learn what determines the capabilities and performance of computer systems and to understand the interactions between the computer's architecture and its software so that future software designers (compiler writers, operating system designers, database programmers, application programmers, ...) can achieve the best cost-performance trade-offs and so that future architects understand the effects of their design choices on software.

## Why Learn This Stuff?

- You want to call yourself a "computer scientist/engineer"
- You want to build HW/SW people use (so need performance/power)
- You need to make a purchasing decision or offer "expert" advice


## Both hardware and software affect performance/power

- Algorithm determines number of source-level statements
- Language/compiler/architecture determine the number of machine-level instructions
- Processor/memory determine how fast and how power-hungry machine-level instructions are executed


## What You Should Already Know

- Basic logic design \& machine organization
- logical minimization, FSMs, component design
- processor, memory, I/O
- Create, run, debug programs in an assembly language
- Will be introduced in tutorial
- Create, compile, and run C/C++ programs
- Create, organize, and edit files and run programs on Unix/Linux


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One example here!

## Computer Organization and Design

- This course is all about how computers work
- But what do we mean by a computer?
- Different types: embedded, laptop, desktop, server
- Different uses: automobiles, graphics, finance, genomics ..
- Different manufacturers: Intel, Apple, IBM, Sony, Oracle ...
- Different underlying technologies and different costs
- Analogy: Consider a course on "automotive vehicles"
- Many similarities from vehicle to vehicle (e.g., wheels)
- Huge differences from vehicle to vehicle (e.g., gas vs. electric)
- Best way to learn:
- Focus on a specific instance and learn how it works
- While learning general principles and historical perspectives


## How Do the Pieces Fit Together?



- Coordination of many levels of abstraction
- Under a rapidly changing set of forces
- Design, measurement, and evaluation


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A Bit of History

When was the first transistor invented?

(a)

(b)
(a) 1947, bi-polar transistor, by John Bardeen et al. at Bell Laboratories; (b) UNIVAC I (Universal Automatic Computer): the first commercial computer in USA.

When was the first IC (integrated circuit) invented?

(a)

(b)
(a) 1958, by Jack Kilby@Texas Instruments, by hand. Several transistors, resistors and capacitors on a single substrate. (b) IBM System/360, 2MHz, 128KB - 256KB.

The Evolution of Computer Hardware

When was the first Microprocessor?


1971, Intel 4004.

## The IC Manufacturing Process



## Yield

Proportion of working dies per wafer
Check this: https://youtu.be/d9SWNLZvA8g?list=FLELqiXCJQW-jcijW8ZAbA8w


300 mm wafer, 117 chips, 90 nm technology.

$$
\text { Cost per die }=\frac{\text { Cost per wafer }}{\text { Dies per wafer } \cdot \text { Yield }}
$$

Dies per wafer $=$ Wafer area $/$ Die area

$$
\text { Yield }=\frac{1}{[1+(\text { Defects per area } \cdot \text { Die area } / 2)]^{2}}
$$

## Nonlinear relation to area and defect rate

- Wafer cost and area are fixed
- Defect rate determined by manufacturing process
- Die area determined by architecture and circuit design


## Processor

- Logic capacity: increases about $30 \%$ per year
- Performance: $2 \times$ every 1.5 years


## Memory

- DRAM capacity: $4 \times$ every 3 years, about $60 \%$ per year
- Memory speed: $1.5 \times$ every 10 years
- Cost per bit: decreases about $25 \%$ per year


## Disk

- Capacity: increases about $60 \%$ per year


## Moore's Law - 2005



From: "Facing the Hot Chips Challenge Again", Bill Holt, Intel, presented at Hot Chips 17, 2005.


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| Year | $\mathbf{2 0 0 4}$ | $\mathbf{2 0 0 6}$ | $\mathbf{2 0 0 8}$ | $\mathbf{2 0 1 0}$ | $\mathbf{2 0 1 2}$ |
| :---: | :---: | :---: | :---: | :---: | :---: |
| Feature size (nm) | 90 | 65 | 45 | 32 | 22 |
| Intg. Capacity (BT) | 2 | 4 | 6 | 16 | 32 |

Fun facts about 45nm transistors

- 30 million can fit on the head of a pin
- You could fit more than 2,000 across the width of a human hair
- If car prices had fallen at the same rate as the price of a single transistor since 1968, a new car today would cost about 1 cent


## Highest Clock Rate of Intel Processors



## Highest Clock Rate of Intel Processors



What if the exponential increase had kept up? Why not?

- Due to process improvements
- Deeper pipeline
- Circuit design techniques

$$
\text { Power }=\text { Capacitive load } \cdot \text { Voltage }^{2} \cdot \text { Frequency }^{1}
$$

## Example

For a simple processor, if capacitive load is reduced by $15 \%$, voltage is reduced by $15 \%$, maintain the same frequency, how much power consumption can be reduced?

[^0]
## A Sea Change Is at Hand

- The power challenge has forced a change in the design of microprocessors
- Since 2002 the rate of improvement in the response time of programs on desktop computers has slowed from a factor of 1.5 per year to less than a factor of 1.2 per year
- As of 2006 all desktop and server companies are shipping microprocessors with multiple processors - cores - per chip
- Plan of record is to add two cores per chip per generation (about every two years)

| Product | AMD <br> Barcelona | Intel <br> Nehalem | IBM Power 6 | Sun Niagara <br> 2 |
| :--- | :---: | :---: | :---: | :---: |
| Cores per chip | 4 | 4 | 2 | 8 |
| Clock rate | $\sim 2.5 \mathrm{GHz}$ | $\sim 2.5 \mathrm{GHz}$ | 4.7 GHz | 1.4 GHz |
| Power | 120 W | $\sim 100 \mathrm{~W}$ | $\sim 100 \mathrm{~W}$ | 94 W |



45 nm technology, $18.9 \mathrm{~mm} \times 13.6 \mathrm{~mm}, 0.73$ billion transistors, 2008

## A Computer


ancomith

## Desktop computers

Designed to deliver good performance to a single user at low cost usually executing 3rd party software, usually incorporating a graphics display, a keyboard, and a mouse

## Other Classes of Computers

## Servers

Used to run larger programs for multiple, simultaneous users typically accessed only via a network and that places a greater emphasis on dependability and (often) security

## Supercomputers

A high performance, high cost class of servers with hundreds to thousands of processors, terabytes of memory and petabytes of storage that are used for high-end scientific and engineering applications.

## Embedded computers (processors)

A computer inside another device used for running one predetermined application

## Supercomputers

Tianhe-2 (MilkyWay-2)

- Over 3 million cores
- Power: 17.6 MW (24 MW with cooling)
- Speed: 33.86 PFLOPS $\left(\right.$ peta $=10^{15}$ )



## Embedded Computers in You Car



## PostPC Era

## Personal Mobile Device (PMD)

Battery-operated device with wireless connectivity


## Warehouse Scale Computer (WSC)

Datacenter containing hundreds of thousands of servers providing software as a service (SaaS)

## Growth in Cell Phone Sales (Embedded)

- embedded growth $\gg$ desktop growth
- Where else are embedded processors found?



## When Machine Learning Meets Hardware

Convolution layer is one of the most expensive layers

- Computation pattern
- Emerging challenges

More and more end-point devices with limited memory

- Cameras
- Smartphone
- Autonomous driving

$\cdots /$
Mabileqe
An (intel company


## Convolutional Neural Network (CNN)

Autonomous drive


Image recognition

feature maps feature maps feature maps feature maps


Convolutional layers account for over $\mathbf{9 0 \%}$ computation
[1] A. Krizhevsky, etc. Imagenet classification with deep convolutional neural networks. NIPS 2012.
[2] J. Cong and B. Xiao. Minimizing computation in convolutional neural networks. ICANN 2014


Max-pooling is optional


## In-Datacenter Performance Analysis of a Tensor Processing Unit ${ }^{\text {TM }}$

Norman P. Jouppi, Cliff Young, Nishant Patil, David Patterson, Gaurav Agrawal, Raminder Bajwa, Sarah Bates, Suresh Bhatia, Nan Boden, Al Borchers, Rick Boyle, Pierre-luc Cantin, Clifford Chao, Chris Clark, Jeremy Coriell, Mike Daley, Matt Dau, Jeffrey Dean, Ben Gelb, Tara Vazir Ghaemmaghami, Rajendra Gottipati, William Gulland, Robert Hagmann, C. Richard Ho, Doug Hogberg, John Hu, Robert Hundt, Dan Hurt, Julian Ibarz, Aaron Jaffey, Alek Jaworski, Alexander Kaplan, Harshit Khaitan, Daniel Killebrew, Andy Koch, Naveen Kumar, Steve Lacy, James Laudon, James Law, Diemthu Le, Chris Leary, Zhuyuan Liu, Kyle Lucke, Alan Lundin, Gordon MacKean, Adriana Maggiore, Maire Mahony, Kieran Miller, Rahul Nagarajan, Ravi Narayanaswami, Ray Ni, Kathy Nix, Thomas Norrie, Mark Omernick, Narayana Penukonda, Andy Phelps, Jonathan Ross, Matt Ross, Amir Salek, Emad Samadiani, Chris Severn, Gregory Sizikov, Matthew Snelham, Jed Souter, Dan Steinberg, Andy Swing, Mercedes Tan, Gregory Thorson, Bo Tian, Horia Toma, Erick Tuttle, Vijay Vasudevan, Richard Walter, Walter Wang, Eric Wilcox, and Doe Hyun Yoon

Google, Inc., Mountain View, CA USA
Email: \{jouppi, cliffy, nishantpatil, davidpatterson\} @google.com
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Figure 3. TPU Printed Circuit Board. It can be inserted in the slot for an SATA disk in a server, but the card uses PCIe Gen $3 \times 16$.


Figure 4. Systolic data flow of the Matrix Multiply Unit. Software has the illusion that each 256B input is read at once, and they instantly update one location of each of 256 accumulator RAMs.

## Apple M1 Processor



- 8-core CPU
- 8-core GPU
- 16-core Neural Engine


[^0]:    ${ }^{1}$ here we only consider dynamic power, but not static power

